File Name	Specification for 2.1" EPD	Module Number	GDE021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	1 of 52

Specification for 2.1" EPD

Model NO.: GDE021A1

Prepared by	Checked by	Approved by

Customer approval

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File Name	Specification for 2.1" EPD	Module Number	GDE021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	2 of 52

Version	Content	Date	Producer

File Name	Specification for 2.1" EPD	Module Number	GDE021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	3 of 52

CONTENTS

1 General Description	6
2 Features	6
3 Application	7
4 Mechanical Specification	7
4.1 Dimension	7
4.2 Mechanical Drawing of EPD Module	8
5 Input/Output Pin Assignment	9
6 Driver IC Functional Block Description	11
6.1 On Chip Display RAM	11
6.2 VCOM Functional	12
6.2.1 VCOM Regulation	12
6.2.2 VCOM Sensing	12
6.3 Oscillator	12
6.4 Booster & Regulator	12
6.5 Waveform Look Up Table (LUT)	13
6.6 OTP	13
6.7 Temperature Searching Mechanism	15
6.8 External Temperature Sensor I ² C Single Master Interface	16
7 Command Table	17
8 Command Description	28

	VersionA/0(For SLC 505a FH E21002-DL Ver02 TFTPage Number	4 of 52
	8.1 Driver Output Control (01h)	28
	8.2 Gate Scan Start Position (0Fh)	30
	8.3 Data Entry Mode Setting (11h)	31
	8.4 Set RAM X - Address Start / End Position (44h)	33
	8.5 Set RAM Y - Address Start / End Position (45h)	33
	8.6 Set RAM Address Counter (4Eh-4Fh)	33
9 '	Typical Operating Sequence	34
	9.1 Normal Display	34
	9.2 The Normal Flow Chart for Display One Screen(WF LUT N	Mode)35
	9.3 Waveform Setting OTP Program	36
	9.4 VCOM OTP Program	37
10	Electrical Characteristics	39
	10.1 Absolute Maximum Rating	39
	10.2 Panel DC Characteristics	39
	10.3 Panel DC Characteristics(Driver IC Internal Regulators)	40
	10.4 Panel AC Characteristics	40
	10.4.1 MCU Interface Selection	40
	10.4.2 MCU Serial Interface (4-wire SPI)	41
	10.4.3 MCU Serial Interface (3-wire SPI)	42
	10.4.4 Interface Timing	42
11	Optical Specification	44

Specification for 2.1" EPD

Module Number

GDE021A1

File Name

File Name	Specification for 2.1" EPD	Module Number	GDE021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	5 of 52

12	Appearance Inspection Standard	45
	12.1 Major Defects	45
	12.2 Minor Defects	45
	12.3 Spot and Line Defect Test and Calculation	46
	12.4 Spot and Line Test Standard	46
	12.5 Air Bubble Defect Test and Calculation	46
13	Handling, Safety, and Environment Requirements	47
14	Reliability Test	48
15	Block Diagram	49
16	Typical Application Circuit with SPI Interface	50
17	Packaging	51
18	Mark and Bar Code Definition	52

File Name	Specification for 2.1" EPD	Module Number	GDE021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	6 of 52

1 General Description

GDE021A1 is an Active Matrix Electrophoretic Display(AMEPD), with interface and a reference system design. The 2.04" active area contains 172x72 pixels, and has 2-bit full display capabilities. The module is a TFT-array driving electrophoretic display, with integrated circuits including gate buffer, source buffer, MCU interface, timing control logic, oscillator, DC-DC, SRAM, LUT, VCOM. Module can be used in portable electronic devices, such as Electronic Shelf Label (ESL) System.

2 Features

- ◆ 172×72 pixels display
- ◆ White reflectance above 30%
- ◆ Contrast ratio above 7:1
- ◆ Ultra wide viewing angle
- ◆ Ultra low power consumption
- ◆ Pure reflective mode
- ♦ Bi-stable display
- ◆ Commercial temperature range
- ◆ Landscape, portrait modes
- ◆ Hard-coat antiglare display surface
- ◆ Ultra Low current deep sleep mode
- On chip display RAM
- ◆ Waveform stored in On-chip OTP
- ◆ Serial peripheral interface available
- ◆ On-chip oscillator
- ◆ On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
- ◆ I²C signal master interface to read external temperature sensor

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	7 of 52

3 Application

Electronic Shelf Label System

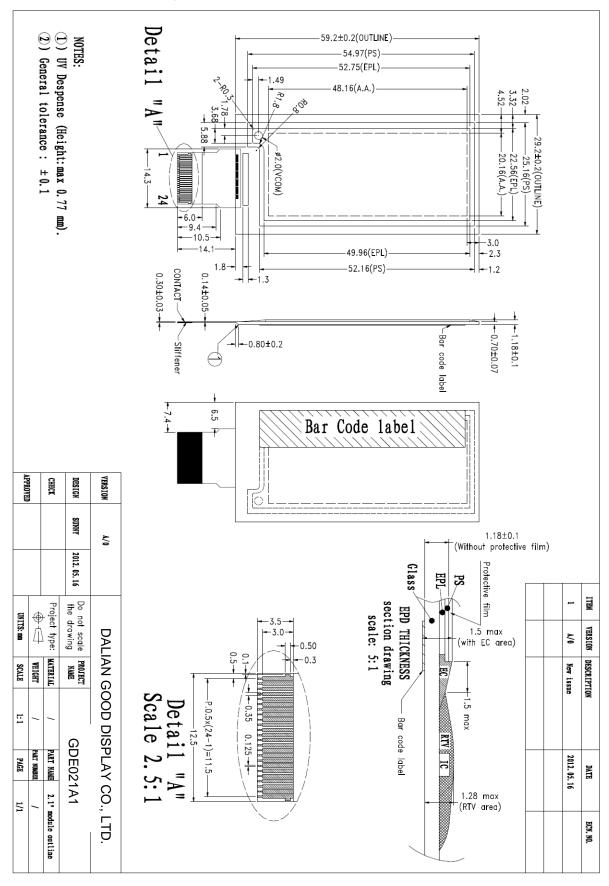
4 Mechanical Specification

4.1 Dimension

Parameter	Value	Unit	Remark
Display resolution	172×72	dots	DPI:90
Active area dimensions Width Height	48.16 20.16	mm mm	
Active screen size	2.04	inch	
Pixel pitch Horizontal Vertical	0.28 0.28	mm mm	
Pixel configuration	Rectangle		
Overall dimensions Width Height Thickness	59.2 29.2 1.5(max.)	mm mm mm	
Mass of the module	3.5±0.5	g	

File Name	Specification for 2.1" EPD	Module Number; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	8 of 52			

4.2 Mechanical Drawing of EPD Module



File Name	Specification for 2.1" EPD	Module Number ''' ''''; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	9 of 52			

5 Input/Output Pin Assignment

No.	Name	I/O	Description	Remark
1	NC		Do not connect with other NC pins	
2	GDR	О	N-Channel MOSFET Gate Drive Control	
3	RESE	I	Current Sense Input for the Control Loop	
4	VGL	С	Negative Gate driving voltage	
5	VGH	С	Positive Gate driving voltage	
6	TSCL	О	I ² C Interface to digital temperature sensor Clock pin	
7	TSDA	I/O	I ² C Interface to digital temperature sensor Data pin	
8	BS1	I	Bus Interface selection pin	Note 5-4
9	BUSY	О	Busy state output pin	Note 5-3
10	RES#	I	Reset signal input. Active Low.	
11	D/C#	I	Data /Command control pin	Note 5-2
12	CS#	I	Chip select input pin	Note 5-1
13	D0	I/O	Serial Clock pin (SPI)	
14	D1	I/O	Serial Data pin (SPI)	
15	VDDIO	P	Power Supply for interface logic pins It should be connected with VCI	
16	VCI	P	Power Supply for the chip	
17	VSS	P	Ground	
18	VDD	С	Core logic power pin VDD can be regulated internally from VCI. A capacitor should be connected between VDD and VSS under all circumstances	
19	VPP	С	Power Supply for OTP Programming	
20	VSH	С	Positive Source driving voltage	
21	PREVGH	С	Power Supply pin for VGH and VSH	
22	VSL	С	Negative Source driving voltage	
23	PREVGL	С	Power Supply pin for VCOM, VGL and VSL	
24	VCOM	С	VCOM driving voltage	

I = Input Pin, O =Output Pin, I/O = Bi-directional Pin (Input/Output), P = Power Pin, C = Capacitor Pin

File Name	Specification for 2.1" EPD	Module Number """; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	10 of 52			

- Note 5-1: This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW.
- Note 5-2: This pin is Data/Command control pin connecting to the MCU in 4-wire SPI mode. When the pin is pulled HIGH, the data at D1 will be interpreted as data. When the pin is pulled LOW, the data at D1 will be interpreted as command.
- Note 5-3: This pin is Busy state output pin. When Busy is High, the operation of chip should not be interrupted, command should not be sent, e.g., The chip would put Busy pin High when
 - Outputting display waveform
 - Programming with OTP
 - Communicating with digital temperature sensor

Note 5-4: Bus interface selection pin

BS1 State	MCU Interface
L	4-lines serial peripheral interface(SPI)
Н	3- lines serial peripheral interface(SPI) - 9 bits SPI

File Name	Specification for 2.1" EPD	Module Number'''' ''''; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	11 of 52			

6 Driver IC Functional Block Description

6.1 On Chip Display RAM

The On chip display RAM is holding the image data. 1 set of RAM is built for historical data and the other set is built for the current image data. The size of each RAM is 128x180x2 bits. In this module, it use the RAM size of 72x172x2 bits for 72x172 resolution. The totally display data for one screen is 3096 bytes.

Shows the RAM map under the following condition:

• Command "Data Entry Mode" R11h is set to:

Address Counter update in X direction	AM=0
X: Increment	ID[1:0] =11
Y: Increment	ID[1:0] =11

• Command "Driver Output Control" R01h is set to

180 Mux	MUX = B3h
Select G0 as 1 st gate	GD = 0
Left and Right gate Interlaced	SM = 0
Scan From G0 to G179	TB = 0

• Command "Gate Start Position" R0Fh is set to:

Set the Start Position of Gate = G0	SCN=0
-------------------------------------	-------

• Data byte sequence: DB0, DB1, DB2 ... DB3095

SOURCE

X-ADDR

		S0	S1	S2	S3	S4	S5	S6	S7	•••	•••	S68	S69	S70	S71
			00h				0	1h		•			11	lh	
G0	00h	DB0 [7:6]	DB0 [5:4]	DB0 [3:2]	DB0 [1:0]	DB1 [7:6]	DB1 [5:4]	DB1 [3:2]	DB1 [1:0]	•••	•••	DB17 [7:6]	DB17 [5:4]	DB17 [3:2]	DB17 [1:0]
G1	01h	DB18 [7:6]	DB18 [5:4]	DB18 [3:2]	DB18 [1:0]	DB19 [7:6]	DB19 [5:4]	DB19 [3:2]	DB19 [1:0]	•••	••	DB35 [7:6]	DB35 [5:4]	DB35 [3:2]	DB35 [1:0]
•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•	•••	•••	•••	•••
•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•	•••	•••	•••	•••
•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•••	•	•••	•••	•••	•••
G170	AAh	DB3060 [7:6]	DB3060 [5:4]	DB3060 [3:2]	DB3060 [1:0]	DB3061 [7:6]	DB3061 [5:4]	DB3061 [3:2]	DB3061 [1:0]	•••	•••	DB3077 [7:6]	DB3077 [5:4]	DB3077 [3:2]	DB3077 [1:0]
G171	ABh	DB3078 [7:6]	DB3078 [5:4]	DB3078 [3:2]	DB3078 [1:0]	DB3079 [7:6]	DB3079 [5:4]	DB3079 [3:2]	DB3079 [1:0]	•••	•••	DB3095 [7:6]	DB3095 [5:4]	DB3095 [3:2]	DB3095 [1:0]

GATE

Y-ADDR

Table 6-1: RAM address map

File Name	Specification for 2.1" EPD	Module Number; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	12 of 52			

6.2 VCOM Functional

6.2.1 VCOM Regulation

This functional block generates the voltage of VCOM, which are necessary for operating an AMEPD.

6.2.2 VCOM Sensing

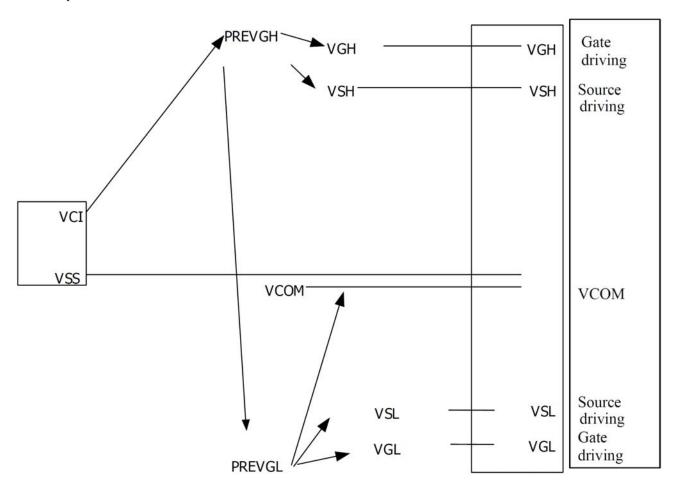
This functional block provides the scheme to select the optimal VCOM DC level and programmed the setting into OTP.

6.3 Oscillator

On-chip oscillator is included for the use on waveform timing and Booster operations.

6.4 Booster & Regulator

A voltage generation system is included in the driver. It provides all necessary driving voltage required for an AMEPD panel.



Max voltage difference between VGH and VGL is 42V.

Figure 6-4: Input and output voltage relation chart

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	13 of 52

6.5 Waveform Look Up Table (LUT)

LUT contains 720 bits, which define the display driving waveform settings. They are arranged in following format.

In Decimal	D 7	D6	D5	D4	D3	D2	D1	D0	
1	VS[0	0-03]	VS[0	VS[0-02]		VS[0-01]		VS[0-00]	
2	VS[0)-13]	VS[0-12]		VS[0	VS[0-11]		VS[0-10]	
3	VS[0)-23]	VS[0	0-22]	VS[0)-21]	VS[0	0-20]	
4	VS[0)-33]	VS[0	0-32]	VS[0-31]		VS[0	0-30]	
5	VS[1	1-03]	VS[1-02]	VS[1	[-01]	VS[1	[00-1	
6	VS[1	1-13]	VS[1-12]	VS[1	[-11]	VS[1-10]		
7	VS[1	1-23]	VS[1-22]		VS[1-21]		VS[1-20]		
8	VS[1	1-33]	VS[1-32]		VS[1-31]		VS[1	1-30]	
•••	•	••	•••		•••		ē	••	
77	VS[1	9-03]	VS[19-02]		VS[19-01]		VS[1	9-00]	
78	VS[1	9-13]	VS[19-12]		VS[19-11]		VS[1	9-10]	
79	VS[1	9-23]	VS[19-22]		VS[19-21]		VS[1	9-20]	
80	VS[1	VS[19-33]		VS[19-32]		VS[19-31]		9-30]	
81		TP	[1]	[1]		TF		P[0]	
82		TP	[3]	[3]		TP			
•••		•					••		
90		TP	[19]	[19]		TP[18]			

Figure 6-5: VS[n-XY] and TP[n] mapping in LUT

6.6 OTP

The OTP is the non-volatile memory and stored the information of:

- OTP Selection Option
- VCOM value
- 11 set of WAVEFORM SETTING (WS) [720bits x 11]
- 10 set of TEMPERATURE RANGE (TR) [24bits x 10]

For Programming the WS and TR, Write RAM is required, and the configurations should be:

Command: Data Entry mode	C11 D03	Set Address automatic increment setting = X increment and Y increment Set Address counter update in X direction
Command: X RAM address start /end	C44 D00 D11	Set RAM Address for S0 to S71
Command: Y RAM address start /end	C45 D00 DAB	Set RAM Address for G0 to G171
Command: RAM X address counter	C4E D00	Set RAM X AC as 0
Command: RAM Y address counter	C4F D00	Set RAM Y AC as 0

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	14 of 52

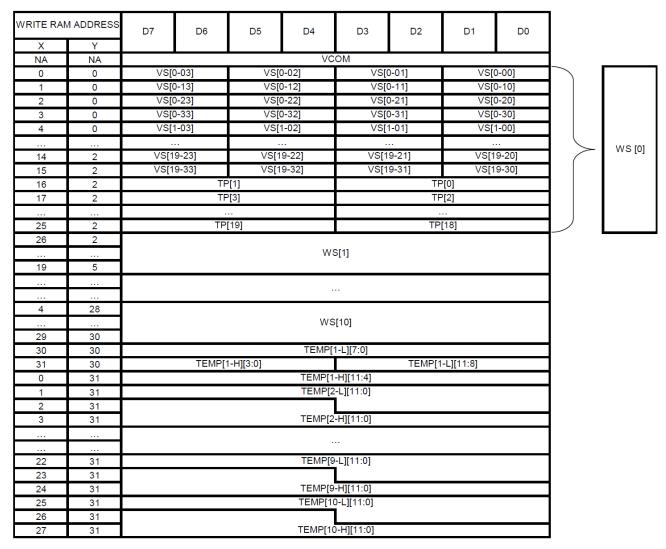


Figure 6-6: OTP Content and Address Mapping

Remark:

- WS [m] means the waveform setting of temperature set m, the configuration are same as the definition in LUT. The corresponding low temperature range of WS[m] defined as TEMP[m-L] and high range defined as TEMP [m-H]
- Load WS [m] from OTP for LUT if Temp [m-L] < Temperature Register <= Temp [m-H]

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	15 of 52

6.7 Temperature Searching Mechanism

Legend:

WS# Waveform Setting no. #						
TR# Temperature Range no. #						
LUT	720 bit register storing the waveform setting (volatile)					
Temperature register	12bit Register storing reading from temperature sensor (volatile)					
OTP	A non-volatile storing 11 sets of waveform setting and 10 set of temperature range					
WS_sel_address	an address pointer indicating the selected WS#					

OTP (non-volatile)

0 ()	
WS0	
WS1	TR1
WS2	TR2
WS3	TR3
WS4	TR4
WS5	TR5
WS6	TR6
WS7	TR7
WS8	TR8
WS9	TR9
WS10	TR10

Table 6-7: Waveform Setting and Temperature Range # mapping

	IC implementation requirement							
1 Default selection is WS0 .								
Compare temperature register from TR1 to TR10 , in sequence. The last match will be i.e. If the temperature register fall in both TR5 and TR7. WS7 will be selected.								
3 If none of the range TR1 to TR10 is match, WS0 will be selected.								
	User application							
1 The default waveform should be programmed as WS0.								
2	There is no restriction on the sequence of TR1, TR2TR10.							

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	16 of 52

6.8 External Temperature Sensor I²C Single Master Interface

The chip provides two I/O lines [TSDA and TSCL] for connecting digital temperature sensor for temperature reading sensing.

TSDA will treat as SDA line and TSCL will treat as SCL line. They are required connecting with external pull-up resistor.

- 1. If the Temperature value MSByte bit D11 = 0, then
 The temperature is positive and value (DegC) = + (Temperature value) / 16
- 2. If the Temperature value MSByte bit D11 = 1, then
 The temperature is negative and value (DegC) = \sim (2's complement of Temperature value) / 16

12-bit binary (2's complement)	Hexadecimal Value	Decimal Value	Value [DegC]
0111 1111 0000	7F0	2032	127
0111 1110 1110	7EE	2030	126.875
0111 1110 0010	7E2	2018	126.125
0111 1101 0000	7D0	2000	125
0001 1001 0000	190	400	25
0000 0000 0010	002	2	0.125
0000 0000 0000	000	0	0
1111 1111 1110	FFE	-2	-0.125
1110 0111 0000	E70	-400	-25
1100 1001 0010	C92	-878	-54.875
1100 1001 0000	C90	-880	-55

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	17 of 52

7 Command Table

Fund	lame	ntal	Com	man	d Tak	ole						
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
1	0	28	0	0	0	0	0	A ₂	A ₁	A ₀	Status Read	Read Driver status on • A2: BUSY flag • A1,A0: Chip ID (01 as default)
											L	
0	0	01	0	0	0	0	0	0	0	1	Driver Output control	Gate setting
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	1 SEX	A[7:0]: MUX setting as A[7:0] + 1
0	1		0	0	0	0	0	B ₂	B ₁	Bo		POR = B3h + 1 MUX B[2:0]: Gate scanning sequence and direction
												B[2]: GD Selects the 1st output Gate GD='0', G0 is the 1st gate output channel, gate output sequence is G0,G1, G2, G3, [POR] GD='1', G1 is the 1st gate output channel, gate output sequence is G1, G0, G3, G2,
												B[1]: SM Change scanning order of gate driver. SM=0, G0, G1, G2, G3G179 (left and right gate interlaced) [POR] SM=1, G0, G2, G4G178, G1, G3,G179 B[0]: TB TB = 0, scan from G0 to G179 [POR] TB = 1, scan from G179 to G0
0	0	02	0	0	0	0	0	0	1	0	Reserve	,
0	0	03	0	0	0	0	0	0	1	1	Gate Driving voltage	Set Gate related driving voltage
0	1	(1.000)	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Control	A[7:4]: VGH, 15 to 22V in 0.5V step

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	18 of 52

	lame				_				_			D
/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
												VGH 0000 15.0 0001 15.5 0010 16.0 0011 16.5 0100 17.0 0101 17.5 0110 18.0 0111 18.5 1000 19.0 1001 19.5 1010 20.0 1011 20.5 1100 21.0 1101 21.5 1110 22.0 [POR] Others N/A A[3:0]: VGL, -15 to -20V in 0.5V step VGL default at -20V VGL 0000 -15.0 0001 -15.5 0010 -16.0 0011 -16.5 0100 -17.0 0101 -17.5 0110 -18.0 0111 -18.5 1000 -19.0 1001 -19.5 1010 -20.0 [POR] Others N/A
0	0	04	0	0	0	0	0	1	0	0	Source Driving voltage Control	Set Source output voltage magnitude
0	1		0	0	0	0	A ₃	A ₂	A ₁	Ao		A[3:0]: VSH/VSL 10V to 17V in 0.5V step VSH/VSL 0000 10.0 0001 10.5 0010 11.0 0011 11.5 0100 12.0 0101 12.5 0110 13.0 0111 13.5 1000 14.0 1001 14.5 1010 15.0 [POR] 1011 15.5 1100 16.0 1101 16.5 1110 17.0
												Others N/A

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	19 of 52

Func	lame	ntal	Com	man	d Tak	ole								
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Descri	ption	
0	0	06	0	0	0	0	0	1	1	0	Reserve			
0	0	07	0	0	0	0	0	1	1	1	Display Control	Display	/ contro	ol setting
0	1		0	0	A ₅	A ₄	0	0	0	Ao		A[0]: G	rey Sc	ale (GS) mode (1bit)
177-20			2000	0.00.0			10000	10,510				Mono v		
												A[0] = 0 $A[0] = 0$		
												7[0] -	i. Wor	9
												In mon		
														rill be treat as 0,
														III be treat as 1 sition between
												GS0 to		
												GS3 to	GS0 c	or GS3
												Δ[4]	A (E)	Description
												A[4]	A[5]	Description All Gate output voltage level
												1	0	as VGH All Gate output voltage level
													U	as VGL
												0	1	Selected gate output as VGL, non-selected gate output as
														VGH
												0	0	Selected gate output as VGH, non-selected gate output as
														VGL
														[POR]
0	0	80	0	0	0	0	1	0	0	0	Reserve			
0	0	09	0	0	0	0	1	0	0	1	Reserve			
0	0	0A	0	0	0	0	1	0	1	0	Reserve	0-4-0-	l 6 -	
0	0	0B	0	0	0	0	1	0	1	1	Gate and Source non overlap period	overlap		
0	1		0	0	0	0	A ₃	A ₂	A ₁	A ₀	Control			dge to source output
Ship	20		2600	800.00	8316	850	0		55563.0	12/33/4	505 SERVICE (S. 1754	change		80 12 1 100 11
												Source	chang	e to Gate rising edge
												Delay [Duratio	n in terms of Oscillator
												clock [
												A [3:0]	Delay Duration
												0000		0
												0001		4
													7	
													Į.	
												0101		10 [POR]
												1110		28
												1111		30
_								2047	_	_				
0	0	0C	0	0	0	0	1	1	0	0	Reserve			
0	0	0D	0	0	0	0	1	1	0	1	Reserve			
0	0	0E	0	0	0	0	1	1	1	0	Reserve	0 /	2022224YA-1-A-2	
0	0	0F	0	0	0	0	1	1	1	1	Gate scan start	Set the	scann	ing start position of the

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	20 of 52

R/W#						ole						
	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	position	gate driver. The valid range is from 0 to 179. TB=0: SCN [7:0] = A[7:0] 00h [POR] TB=1: SCN [7:0] = 179 - A[7:0]00h [POR]
0	0	10	0	0	0	1	0	0	0	0	Deep Sleep mode	Deep Sleep mode Control
0	1		0	0	0	0	0	0	0	A ₀		A[0] : Description 0 [POR] 1 Enter Deep Sleep Mode
0	0	11	0	0	0	1	0	0	0	1	Data Entry mode	Define data entry sequence
0	1		0	0	0	0	0	A ₂	A ₁	Ao	setting	A [1:0]: Address automatic increment / decrement setting The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. 00 –Y decrement, X decrement, 01 –Y decrement, X increment, 11 –Y increment, X increment [POR] A[2]: Set the direction in which the address counter is updated automatically after data are written to the RAM. A[2] = 0, the address counter is updated in the X direction. [POR] A[2] = 1, the address counter is updated in the Y direction.
0	0	12	0	0	0	1	0	0	1	0	SWRESET	It resets the commands and parameters to their S/W Reset default values except R10h-Deep Sleep Mode Note: RAM are unaffected by this command
0	0	13	0	0	0	1	0	0	1	1	Reserve	
0	0	14	0	0	0	1	0	1	0	0	Reserve	
0	0	15	0	0	0	1	0	1	0	1	Reserve	
0	0	16	0	0	0	1	0	1	1	0	Reserve	
0	0	17	0	0	0	1	0	1	1	1	Reserve	
0	0	18 19	0	0	0	1	1	0	0	0	Reserve Reserve	
0	0	19 1A	0	0	0	1	1	0	1	0	Temperature Sensor	Write to temperature register.
0	1	IA	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A _o	Control (Write to	write to temperature register.
0	1		B ₇	B ₆	B ₅	B ₄	0	0	0	0	temperature register)	A[7:0] – MSByte 01111111[POR] B[7:0] – LSByte 11110000[POR]
0	0	1B	0 X ₇	0 X ₆	0 X ₅	1 X ₄	1 X ₃	1 X ₂	0 X ₁	1 X ₀	Temperature Sensor Control (Read from	Read from temperature register. X[7:0] – MSByte

Note: If the module enter deep sleep mode, it must execute hardware RESET function to exit the deep sleep mode.

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	21 of 52

Fund	lame	ntal	Com	man	d Tak	ole						
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
1	1		Y ₇	Y ₆	Y ₅	Y ₄	0	0	0	0	temperature register)	Y[7:4] – LSByte
0	0	1C	0	0	0	1	1	1	0	0	Temperature Sensor	Write Command to temperature sensor
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Control (Write Command to	AI7:61 Soloct no of buto to be cont
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀	temperature sensor	A[7:6] – Select no of byte to be sent 00 – Address + pointer
0	0	1D	0	C ₆	0	C ₄	C ₃	C ₂	0	C ₀	Temperature Sensor Control (Load temperature register	01 – Address + pointer + 1 st parameter 10 – Address + pointer + 1 st parameter + 2 nd pointer 11 – Address A[5:0] – Pointer Setting B[7:0] – 1 st parameter C[7:0] – 2 nd parameter The command required CLKEN=1. Load temperature register with temperature sensor reading
	0	45		•						0	with temperature sensor reading)	BUSY=H for whole loading period The command required CLKEN=1.
0	0	1E	0	0	0	1	1	1	1	0	Reserve	
0	0	1F	0	0	0	1	1	0	1	0	Reserve	Antiveta Display Undeta Conversa
0	U	20	U	0	1	0	0	U	0	U	Master Activation	Activate Display Update Sequence The Display Update Sequence Option is located at R22h User should not interrupt this operation to avoid corruption of panel images.
0	0	21	0	0	1	0	0	0	0	1	Display Update	Option for Display Update

File Name	Specification for 2.1" EPD	Module Number; 89021A	\ 1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number 22 of 52	<u>)</u>

unc	dame	ntal	Com	man	d Tal	ole						
	D/C#		D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	1		A ₇	0	A ₅	A ₄	A ₃	A ₂	A ₁	Ao	Control 1	Bypass Option used for Pattern Display, which is used for display the RAM content into the Display OLD RAM Bypass option A [7] 1 Enable bypass 0 Disable bypass [POR] A[5:4] value will be used as for bypass 00 [POR] A[3:0] Initial Update Option - Source Control
												GSC GSD A[3:2] A[1:0] 0000 GS0 GS0 0001 GS0 GS1 0010 GS0 GS2 0011 GS0 GS3 [POR] 0100 GS1 GS0 0101 GS1 GS1 0110 GS1 GS2 0111 GS1 GS3 1000 GS2 GS0 1001 GS2 GS1 1010 GS2 GS1 1010 GS2 GS2 1011 GS2 GS3 1100 GS3 GS0 1101 GS3 GS0 1101 GS3 GS1 1110 GS3 GS2 1111 GS3 GS3
0	0	22	0	0	1	0	0	0	1	0	Display Update	000 000

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	23 of 52

	lame	Hex		D6	D5	D4	D3	D2	D1	D0	Command	Description
0	1	пех	A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Control 2	Enable the stage for Master Activati
												Paramete (in Hex)
												Enable Clock Signal, Then Enable CP Then Load Temperature value Then Load LUT Then INIITIAL DISPLAY Then PATTERN DISPLAY Then Disable CP Then Disable OSC
												Enable Clock Signal, Then Enable CP Then Load Temperature value Then Load LUT Then PATTERN DISPLAY Then Disable CP Then Disable OSC
												To Enable Clock Signal (CLKEN=1) 80
												To Enable Clock Signal, then Enable CP C0 (CLKEN=1, CPEN=1)
												To INITIAL DISPLAY + PATTEN OC DISPLAY
												To INITIAL DISPLAY 08
												To DISPLAY PATTEN 04
												To Disable CP, then Disable Clock Signal 03 (CLKEN=1, CPEN=1)
												To Disable Clock Signal (CLKEN=1) 01
												Remark: CLKEN=1: If CLS=VDDIO then Enable OSC If CLS=VSS then Enable External C CLKEN=0: If CLS=VDDIO then Disable OSC AND INTERNAL CLOCK Signal = VSS,
0	0	23	0	0	1	0	0	0	1	1	Reserve	
0	0	24	0	0	1	0	0	1	0	0	Write RAM	After this command, data entries wil written into the RAM until another command is written. Address pointe will advance accordingly.
0	0	25	0	0	1	0	0	1	0	1	Read RAM	After this command, data read on the MCU bus will fetch data from RAM, another command is written. Address pointers will advance accordingly.
0	0	26	0	0	1	0	0	1	1	0	Reserve	
0	0	27	0	0	1	0	0	1	1	1	Reserve	

File Name	Specification for 2.1" EPD	Module Number '''	''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	24 of 52

Func	lame	ntal	Com	man	d Tal	ole						
	D/C#		D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	28	0	0	1	0	1	0	0	0	VCOM Sense	Enter VCOM sensing conditions and hold for duration defined in 29h before reading VCOM value. The sensed VCOM voltage is stored in register The command required CLKEN=1.
0	0	29	0	0	1	0	1	0	0	1	VCOM Sense	Stabling time between entering VCOM
0	1		0	0	0	0	A ₃	A ₂	A ₁	Ao	Duration	sensing mode and reading acquired. VCOM sense duration = Setting + 1 Seconds 0x09(10Seconds) [POR]
0	0	2A	0	0	1	0	1	0	1	0	Program VCOM OTP	Program VCOM register into OTP
0	0	2B	0	0	1	0	1	0	1	1	Reserve	
0	0	2C	0	0	1	0	1	0	1	1	Write VCOM register	Write VCOM register from MCU
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		interface
0	0	2D	0	0	1	0	1	1	0	1	Read OTP Registers	Read register reading to MCU
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A [7:0] Spare OTP Option B [7:0] VCOM Register
1	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		B [7:0] VOCWI Negister
0	0	2E	0	0	1	0	1	1	1	0	Reserve	
0	0	2F	0	0	1	0	1	1	1	1	Reserve	
0	0	30	0	0	1	1	0	0	0	0	Program WS OTP	Program OTP of Waveform Setting The contents should be written into RAM before sending this command.
0	0	31	0	0	1	1	0	0	0	1	Reserve	
0	0	32	0	0	1	1	0	0	1	0	Write LUT register	Write LUT register from MCU [720 bits]
000:00	1 1 1 1					Ll [90 b						
0	0	33	0	0	1	1	0	0	1	1	Read LUT register	Read from LUT register (excluding
1	1											temperature data) [720 bits]
1	1					LU						
1	1					[90 b	100					
1	1						,1					
1	1								- 2			
0	0	34	0	0	1	1	0	1	0	0	Reserve	
0	0	35	0	0	1	1	0	1	0	1	Reserve	Drawn CTD Colortina according to the
0	0	36	0	0	1	1	0	1	1	0	Program OTP selection	Program OTP Selection according to the OTP Selection Control [R36h]
0	0	37	0	0	1	1	0	1	1	1	OTP selection	Write the OTP Selection:

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	25 of 52

unc	lame	ntal	Com	man	d Tal	ole						
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Control	A[7]=1 spare VCOM OTP A[6] VCOM_Status A[5]=1 spare WS OTP A[4] WS_Status A3:A0 are reserved OTP bit. User can treat the bits as Version Control.
0	0	38	0	0	1	1	1	0	0	0	Reserve	
0	0	39	0	0	1	1	1	0	0	1	Reserve	
0	0	ЗА	0	0	1	1	1	0	1	0	Set dummy line	Set number of dummy line period
0	1		0	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	Ao	period	A[6:0]: Number of dummy line period in term of TGate 4 [POR] Available setting 0 to 127.
0	0	3B	0	0	1	1	1	0	1	1	Set Gate line width	Set Gate line width (TGate)
0	1		0	0	0	0	A ₃	A ₂	A ₁	Ao		A[3:0] Line width in us 0000
		20	_	_				_		_	Davida W	Onland handan way for VDD
0	0	3C	0	0	1	1	1	1	0	0	Border Waveform	Select border waveform for VBD

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	26 of 52

Fund	dame	ntal	Com	man	d Tal	ole						
R/W#							D3	D2	D1	D0	Command	Description
0	1	Hex	D7 A7	P6 A6	A5	D4 A4	A ₃	A ₂	A ₁	D0 A ₀	Control	Description
		20	_	_	4	4	4	4			December	1111 GS3 GS3
0	0	3D 3E	0	0	1	1	1	1	1	0	Reserve Reserve	
0	0	3F	0	0	1	1	1	1	1	1	Reserve	
0	0	40	0	1	0	0	0	0	0	0	Reserve	
0	0	41	0	1	0	0	0	0	0	1	Reserve	
0	0	42	0	1	0	0	0	0	1	0	Reserve	
0	0	43	0	1	0	0	0	0	1	1	Reserve	
0	0	44	0	1	0	0	0	1	0	0	Set RAM X - add	
0	1		0	0	0	A ₄	A ₃	A ₂	A ₁	A ₀	Start / End position	

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	27 of 52

Func	dame	ntal	Com	man	d Tak	ole						
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	1		0	0	0	B ₄	B ₃	B ₂	B ₁	B ₀		address unit A[7:0]: XStart, POR = 00h B[7:0]: XEnd, POR = 1Fh
0	0	45	0	1	0	0	0	1	0	1	Set Ram Y- address	Specify the start/end positions of the
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Start / End position	window address in the Y direction by an
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		address unit A[7:0]: YStart, POR = 00h B[7:0]: YEnd, POR = B3h
0	0	46	0	1	0	0	0	1	1	0	Reserve	
0	0	47	0	1	0	0	0	1	1	1	Reserve	
0	0	48	0	1	0	0	1	0	0	0	Reserve	
0	0	49	0	1	0	0	1	0	0	1	Reserve	
0	0	4A	0	1	0	0	1	0	1	0	Reserve	
0	0	4B	0	1	0	0	1	0	1	1	Reserve	
0	0	4C	0	1	0	0	1	1	0	0	Reserve	
0	0	4D	0	1	0	0	1	1	0	1	Reserve	
0	0	4E	0	1	0	0	1	1	1	0	Set RAM X address	Make initial settings for the RAM X
0	1		0	0	0	A ₄	A ₃	A ₂	A ₁	A ₀	counter	address in the address counter (AC) POR is 0
0	0	4F	0	1	0	0	1	1	1	1	Set RAM Y address	Make initial settings for the RAM Y
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	counter	address in the address counter (AC) POR is 0
0	0	F0	1	1	1	1	0	0	0	0	Booster Feedback	Set Booster Feedback selection
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀	Selection	0x1F = Internal Feedback is used POR is 0x1F
0	1	FF	1	1	1	1	1	1	1	1	NOP	This command is an empty command; it does not have any effect on the display module. However it can be used to terminate Frame Memory Write or Read Commands.

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	28 of 52

8 Command Description

8.1 Driver Output Control (01h)

This double byte command has multiple configurations and each bit setting is described as follows:

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	MUX7	MUX6	MUX5	MUX4	MUX3	MUX2	MUX1	MUX0
POR		1	0	1	1	0	0	1	1
W	1						GD	SM	TB
POR							0	0	0

MUX[7:0]: Specify number of lines for the driver: MUX[7:0] + 1. Multiplex ratio (MUX ratio) from 16 MUX to 180MUX.

GD: Selects the 1st output Gate

This bit is made to match the GATE layout connection on the panel. It defines the first scanning line.

SM: Change scanning order of gate driver.

When SM is set to 0, left and right interlaced is performed.

When SM is set to 1, no splitting odd / even of the GATE signal is performed, Output pin assignment sequence is shown as below (for 180 MUX ratio):

	SM=0	SM=0	SM=1	SM=1
Driver	GD=0	GD=1	GD=0	GD=1
G0	ROW0	ROW1	ROW0	ROW90
G1	ROW1	ROW0	ROW90	ROW0
G2	ROW2	ROW3	ROW1	ROW91
G3	ROW3	ROW2	ROW91	ROW1
:	:	:	:	:
G88	ROW88	ROW89	ROW44	ROW134
G89	ROW89	ROW88	ROW134	ROW44
G90	ROW90	ROW91	ROW45	ROW135
G91	ROW91	ROW90	ROW135	ROW45
:	:	:	:	:
G176	ROW176	ROW177	ROW88	ROW178
G177	ROW177	ROW176	ROW178	ROW88
G178	ROW178	ROW179	ROW89	ROW179
G179	ROW179	ROW178	ROW179	ROW89

See "Scan Mode Setting" on next page.

TB: Change scanning direction of gate driver.

This bit defines the scanning direction of the gate for flexible layout of signals in module either from up to down (TB=0) or from bottom to up (TB=1).

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	29 of 52

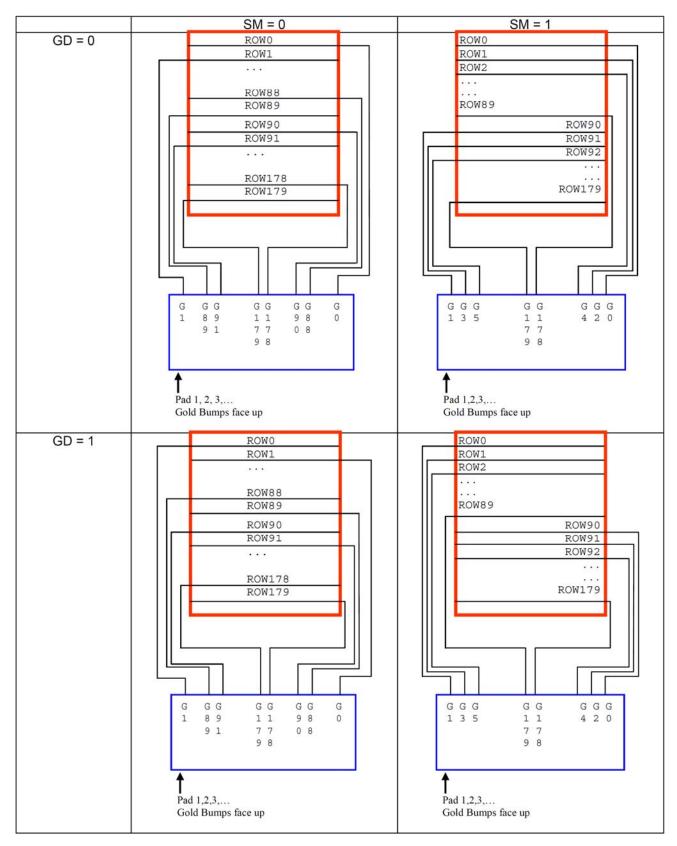


Figure 8-1: Output pin assignment on different Scan Mode Setting

File Name	Specification for 2.1" EPD	Module Number ''' ''''; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	30 of 52			

8.2 Gate Scan Start Position (0Fh)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	SCN7	SCN6	SCN5	SCN4	SCN3	SCN2	SCN1	SCN0
PC)R	0	0	0	0	0	0	0	0

This command is to set Gate Start Position for determining the starting gate of display RAM by selecting a value from 0 to 179. Figure 8-2 shows an example using this command of this command when MUX ratio =180 and MUX ratio = 90. "ROW" means the graphic display data RAM row.

	MUX ratio (01h) = 179	MUX ratio (01h) = 89	MUX ratio (01h) = 89
GATE Pin	Gate Start Position $(0Fh) = 0$	Gate Start Position $(0Fh) = 0$	Gate Start Position (0Fh) = 45
GATE I III	ROW0	ROW0	- Cate Start I Osition (OI II) 43
G1	ROW1	ROW1	<u> </u>
G2	ROW1	ROW1	-
G2 G3	ROW2 ROW3	ROW2	-
:	:	:	<u> </u>
:	:	:	:
G43	:	:	-
G44	:	:	_
G45	:	:	ROW45
G46	:	:	ROW46
:	:	:	:
:	:	:	:
G88	ROW88	ROW88	:
G89	ROW89	ROW89	:
G90	ROW90	-	:
G91	ROW91	_	:
:	:	:	:
:	:	:	:
G133	:	:	ROW133
G134	:	•	ROW134
G135	:	•	-
G136	:	:	-
:	:	:	:
:	:	:	:
G176	ROW176	-	-
G177	ROW177	-	-
G178	ROW178	-	-
G179	ROW179	-	-
Display Example	SALE ing	SALE ing	Y 20057

Figure 8-2: Example of Set Display Start Line with no Remapping

File Name	Specification for 2.1" EPD	Module Number '''	'''''; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	31 of 52

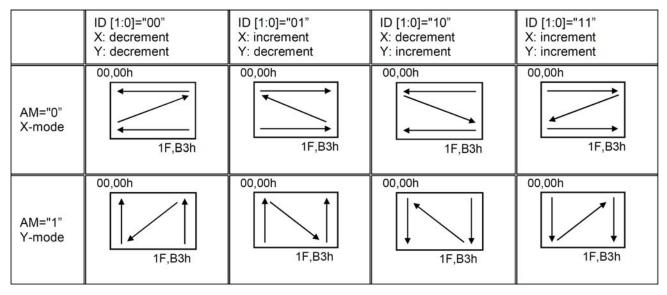
8.3 Data Entry Mode Setting (11h)

This command has multiple configurations and each bit setting is described as follows:

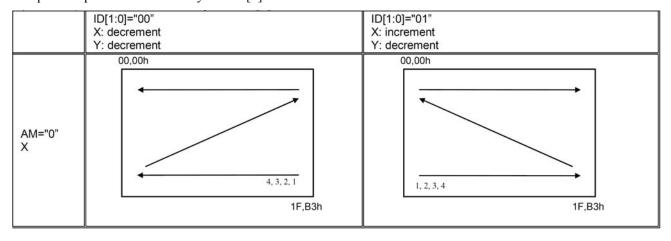
R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1						AM	ID1	ID0
PC)R	0	0	0	0	0	0	0	0

ID[1:0]: The address counter is automatically incremented by 1, after data are written to the RAM when ID[1:0] = "1". The address counter is automatically decremented by 1, after data are written to the RAM when ID[1:0] = "0". The setting of incrementing or decrementing of the address counter can be made independently in each upper and lower bit of the address. The direction of the address when data are written to the RAM is set with AM bits.

AM: Set the direction in which the address counter is updated automatically after data are written to the RAM. When AM = "0", the address counter is updated in the X direction. When AM = "1", the address counter is updated in the Y direction. When window addresses are selected, data are written to the RAM area specified by the window addresses in the manner specified with ID1-0 and AM bits.



The pixel sequence are defined by the ID [0]



File Name	Specification for 2.1" EPD	Module Number "; 89021A1			
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	32 of 52		

The totally image display style setting is shown as below table:

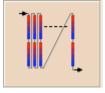
REG#	Style 1	Style 2	Style 3	Style 4	
11h	0x03	0x02	0x01	0x00	
44h	0x00	0x00 0x11		0x11	
4411	0x11	0x00	0x11	0x00	
45h	0x00	0x00	0xAB	.0xAB	
4311	0xAB	0xAB	0x00	0x00	
4Eh	0x00	0x11	0x00	0x11	
4Fh	0x00	0x00	0xAB	0xAB	
Image display sample	G171	G0 S71	G171	S0 S71	

1 Original image:



2 Scanning direction: vertical scan mode

Display data distilling format setting



3 Image display mode: Reversal display



- 4 The max. width:172 The max. height:72
- 5 Output gray: 4 gray

File Name	Specification for 2.1" EPD	Module Number "; 89021A1				
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	33 of 52			

8.4 Set RAM X - Address Start / End Position (44h)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1				XSA4	XSA3	XSA2	XSA1	XSA0
PC)R	0	0	0	0	0	0	0	0
W	1				XEA4	XEA3	XEA2	XEA1	XEA0
PC)R	0	0	0	1	1	1	1	1

XSA[4:0]/XEA[4:0]: Specify the start/end positions of the window address in the X direction by 4 times address unit. Data are written to the RAM within the area determined by the addresses specified by XSA [4:0] and XEA [4:0]. These addresses must be set before the RAM write. It allows on XEA [4:0] ≤ XSA [4:0]. The settings follow the condition on 00h ≤ XSA [4:0], XEA [4:0] ≤ 1Fh. The windows is followed by the control setting of Data Entry Setting (R11h).

8.5 Set RAM Y - Address Start / End Position (45h)

R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
W	1	YSA7	YSA6	YSA5	YSA4	YSA3	YSA2	YSA1	YSA0
PC)R	0	0	0	0	0	0	0	0
W	1	YEA7	YEA6	YEA5	YEA4	YEA3	YEA2	YEA1	YEA0
PC)R	1	1	0	1	0	0	1	1

YSA[7:0]/YEA[7:0]: Specify the start/end positions of the window address in the Y direction by an address unit. Data are written to the RAM within the area determined by the addresses specified by YSA [7:0] and YEA [7:0]. These addresses must be set before the RAM write. It allows YEA [7:0] ≤ YSA [7:0]. The settings follow the condition on 00h ≤ YSA [7:0], YEA [7:0] ≤ B3h. The windows is followed by the control setting of Data Entry Setting (R11h).

8.6 Set RAM Address Counter (4Eh-4Fh)

REG#	R/W	DC	IB7	IB6	IB5	IB4	IB3	IB2	IB1	IB0
4Eh	W	1				XAD4	XAD3	XAD2	XAD1	XAD0
4EII	POR		0	0	0	0	0	0	0	0
4Eh	W	1	YAD7	YAD6	YAD5	YAD4	YAD3	YAD2	YAD1	YAD0
4Fh	PC)R	0	0	0	0	0	0	0	0

XAD[4:0]: Make initial settings for the RAM X address in the address counter (AC). **YAD[7:0]:** Make initial settings for the RAM Y address in the address counter (AC).

After RAM data are written, the address counter is automatically updated according to the settings with AM, I/D bits and setting for a new RAM address is not required in the address counter. Therefore, data are written consecutively without setting an address. The address counter is not automatically updated when data are read out from the RAM. RAM address setting cannot be made during the standby mode. The address setting should be made within the area designated with window addresses which is controlled by the Data Entry Setting (R11h) {AD, ID[1:0]}; RAM Address XStart / XEnd Position (R44h) and RAM Address Ystart / Yend Position (R45h). Otherwise undesirable image will be displayed on the Panel.

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	34 of 52

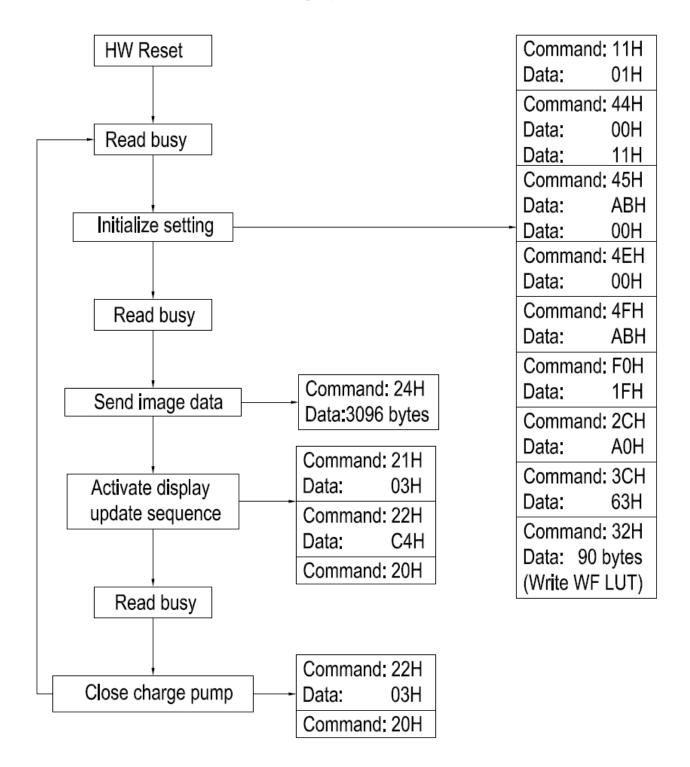
9 Typical Operating Sequence

9.1 Normal Display

Sequence	Action by	Command	Action description	Remark
1	User	-	Power on (VCI supply)	
2	User	-	HW Reset	
	IC		After HW reset, the IC will have Registers load with POR value Ready for command input VCOM register loaded with OTP value IC enter idle mode	
3		-	Send initial code to driver including setting of	
	User	C 01	Command: Panel configuration (MUX, Source gate scanning direction)	
	User	C 03	Command: VGH / VGL voltage	
	User	C 04	Command: VSH / VSL voltage	
	User	C 3A	Command: Set dummy line pulse period	
	User	C 3B	Command: Set Gate line width	
	User	C 3C	Command: Select Border waveform	
4		-	Data operations	
	User	C 11	Command: Data Entry mode	
	User	C 44	Command: X RAM address start /end	
	User	C 45	Command: Y RAM address start /end	
	User	C 4E	Command: RAM X address counter	
	User	C 4F	Command: RAM Y address counter	
	User	C 24	Command: write display data to RAM	
			Ram Content for Display	
5	User	C F0 D 1F	Command: Set Internal Feedback Selection	
6	User	C 20	Command: Display update	
	IC	-	Booster and regulators turn on	
	IC	-	Load temperature register with sensor reading	
	IC	-	Load LUT register with corresponding waveform setting stored in OTP	
	IC	-	Send output waveform according initial update option	
	IC	-	Send output waveform according to data	
	IC	-	Booster and Regulators turn off	
	IC	-	Back to idle mode	
7	User	-	IC power off	

File Name	Specification for 2.1" EPD	Module Number	; 89M021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	35 of 52

9.2 The Normal Flow Chart for Display One Screen(WF LUT Mode)



File Name		Specification for 2.1" EPD	Module Number	; 89021A1
	Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	36 of 52

9.3 Waveform Setting OTP Program

Sequence	Action by	Command	Action description	Remark
1	User	-	Power on (VCI supply)	
2	User	-	Power on (VPP supply)	
3	User	-	HW Reset	
4	User	C 2D	Check whether the IC status and determine whether "default" or "spare" OTP should be used	
5	User		If the IC had been OTP twice (both default and spare had been used up). The operation should stop	
6	User	C 37	Proceed OTP sequence. Command: Indicate which OTP location to be use (default or spare)	OTP selection register
	User	C 22 D 80 C 20	Command: CLKEN=1	
	User	-	Wait BUSY = L	
7	User	C 36	Program OTP selection register	
	User	-	Wait BUSY = L	
8	User	C 24	Write corresponding data into RAM	
			Following specific format	
			Write into RAM	
			Full LUT (11 entries + Temperature range) must be written at the same time	
	User	C 4E D 00 C 4F D 00	Command: Initial Ram address counter	
9	User	C 30	Waveform Setting OTP programming	
	IC	-	BUSY pin pull H	
	IC	-	Check the OTP Selection	
	IC	-	IC control OTP programming time, and transfer data to selected OTP	
	IC	-	BUSY pin pull L	
	User	-	Wait BUSY = L	
10	User	C 22 D 01 C 20	Command: CLKEN=0	
	User	-	Wait BUSY = L	
11	User		IC power off	

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	37 of 52

9.4 VCOM OTP Program

Sequence	Action by	Command	Action description	Remark
1	User	-	Power on (VCI and VPP supply)	
2	User	-	HW Reset	
3	User	C 2D	Check whether the IC status and determine whether "default" or "spare" OTP should be used	
4	User		If the IC had been OTP twice (both default and spare had been used up). The operation should stop	
5	User	C 37	Proceed OTP sequence. Command: Indicate which OTP location to be use (default or spare)	OTP selection register
	User	C 22 D 80 C 20	Command: CLKEN=1	
	User	-	Wait until BUSY = L	
6	User	C 36	Program OTP selection register	
	User	-	Wait until BUSY = L	
	User	-	Power OFF (VPP supply)	
7		-	Send initial code to driver including setting of (or leave as POR)	
	User	C 01	Command: Panel configuration (MUX, Source, Gate scanning direction)	
	User	C 03	Command: VGH / VGL voltage	
	User	C 04	Command: VSH / VSL voltage	VCOM
	User	C 3A	Command: Set dummy line pulse period	sensing
	User	C F0 D 1F	Command: Set Internal Feedback Selection	should have same
	User	C 32	VCOM sense required full set of LUT for operation, USER required writing LUT in register 32h	setting during application
		-	LUT parameter	аррисацоп
	User	C 22 D 40 C 20	Command: Booster on and High voltage ready	
	User	-	Wait until BUSY = L	
8	User	C 28	Command: Enter VCOM sensing mode	
	IC	-	VCOM pin in sensing mode	
	IC		All Source cell have VSS output	
	IC	-	All Gate scanning continuously	
	IC	-	Wait for 10s	According to
	IC	-	Detect VCOM voltage and store in register	R29h
	IC	-	All Gate Stop Scanning.	
	User	-	Wait until BUSY = L	

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	38 of 52

9	User	C 22 D 02 C 20	Command: Booster and High voltage disable	
	User	1	Wait until BUSY = L	
	User	1	Power On (VPP supply)	
10	User	C 2A	Command: VCOM OTP program	
	User	ı	Wait until BUSY = L	
11	User	C 22 D 01 C 20	Command: CLKEN=0	
	User	-	Wait until BUSY = L	
12	User	-	IC power off (VCI and VPP Supply)	

OTP Selection bit:

Set on R37h, and read from R2Dh, A[7:6] used for VCOM and A[5:4] used for OTP

A[7:6] / [5:4]	Description
00	It indicates fresh device, OTP read and program would be made on Default OTP set.
00	User required setting and programming the bits into 01.
0.1	It indicates default OTP programmed device, OTP read would be made on Default OTP set.
01	User require setting and programming the bits into 11.
	It indicates SPARE OTP programmed device, only OTP read would be made on SPARE OTP
11	set.
	User should stop the OTP programming if 11 is found at OTP checking stage.

File Name	Specification for 2.1" EPD	Module Number	····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	39 of 52

10 Electrical Characteristics

10.1 Absolute Maximum Rating

Parameter	Symbol	Rating	Unit
Logic supply voltage	V_{CI}	-0.5 to +3.6	V
Logic Input voltage	V_{IN}	-0.5 to $V_{CI} + 0.5$	V
Logic Output voltage	$V_{ m OUT}$	-0.5 to $V_{CI} + 0.5$	V
Operation temperature range	T_{OPR}	0 to +50	°C
Storage temperature range	T_{STG}	-20 to +70	°C

Note: Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Panel DC Characteristics tables.

10.2 Panel DC Characteristics

The following specifications apply for: VSS=0V, VCI=3.0V, T_{OPR} =25°C.

Parameter	Symbol	Condition	Applicable pin	Min.	Тур.	Max.	Unit
Logic supply voltage	V _{CI}	-	VCI	2.4	3.0	3.3	V
High level input voltage	$V_{ m IH}$	-	-	$0.8~V_{CI}$	1	-	V
Low level input voltage	$ m V_{IL}$	-	-	-	-	$0.2~V_{CI}$	V
High level output voltage	V_{OH}	IOH = -100uA	-	0.9 V _{CI}	-	-	V
Low level output voltage	V_{OL}	IOL = 100uA	-	-	ı	$0.1~V_{CI}$	V
OTP Program voltage	V_{PP}	-	VPP	-	7.5	-	V
Typical power panel	P_{TYP}	-	-	-	24	36	mW
Standby power panel	P_{STPY}	-	-	-	0.006	-	mW
Typical operating current	Iopr_VCI	-	-	-	8.0	-	mA
Sleep mode current	Islp_VCI	VCI=3.3V DC/DC OFF No clock No output load Ram data retain	VCI	-	35	50	uA
Deep sleep mode current	Idslp_VCI	VCI=3.3V DC/DC OFF No clock No output load Ram data not retain	VCI	-	2	5	uA
Operation temperature range	T_{OPR}	-	-	0	-	50	°C
Storage temperature range	T_{STG}	-	-	-20	-	70	°C

Notes: 1. The typical operating current is measured with following transition: from horizontal 4 gray scale pattern to vertical 4 gray scale pattern. (Figure 10-2)

It include DC-DC circuit current with the component parameter of the typical application circuit on page 50.

2. The standby power is the consumed power when the panel controller is in standby mode.

OED Confidential Page 39 of 52 2012-10-22

File Name	Specification for 2.1" EPD	Module Number; 89021A1		
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	40 of 52	

3. The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by OED.

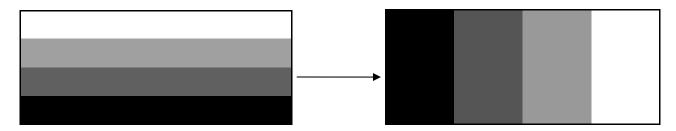


Figure 10-2 The typical power consumption measure pattern

10.3 Panel DC Characteristics(Driver IC Internal Regulators)

The following specifications apply for: VSS=0V, VCI=3.0V, T_{OPR} =25°C.

Parameter	Symbol	Condition	Applicable pin	Min.	Тур.	Max.	Unit
VDD operation voltage	VDD	-	VDD	1.7	1.8	1.9	V
VCOM output voltage	VCOM	-	VCOM	-4.0	-	+0.2	V
Gate output voltage	V_{GATE}	-	G0-171	-20	-	+22	V
Gate output peak to peak voltage	V _{GATE(p-p)}	-	G0-171	-	-	42	V
Positive Source output voltage	V_{SH}	-	S0-71	+10	-	+17	V
Negative Source output voltage	V_{SL}	-	S0-71	-	-V _{SH}	-	V

10.4 Panel AC Characteristics

10.4.1 MCU Interface Selection

MCU interface consist of 2 data/command pins and 3 control pins. The pin assignment at different interface mode is summarized in Table 10-4-1. Different MCU mode can be set by hardware selection on BS1 pins. The display panel only supports 4-wire SPI or 3-wire SPI interface mode.

Pin Name	Data/Connn	and Interface	Control Signal		
Bus interface	D1	D0	CS#	D/C#	RES#
4-wire SPI	SDIN	SCLK	CS#	D/C#	RES#
3-wire SPI	SDIN	SCLK	CS#	L	RES#

Table 10-4-1: MCU interface assignment under different bus interface mode

File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	41 of 52

10.4.2 MCU Serial Interface (4-wire SPI)

The serial interface consists of serial clock SCLK, serial data SDIN, D/C#, CS#. In 4-wire SPI mode, D0 acts as SCLK, D1 acts as SDIN.

Function	CS#	D/C#	SCLK
Write command	L	L	↑
Write data	L	Н	↑

Note: \(\gamma\) stands for rising edge of signal

Table 10-4-2: Control pins of 4-wire Serial interface

SDIN is shifted into an 8-bit shift register on every rising edge of SCLK in the order of D7, D6, ... D0. D/C# is sampled on every eighth clock and the data byte in the shift register is written to the Graphic Display Data RAM (RAM) or command register in the same clock.

Under serial mode, only write operations are allowed.

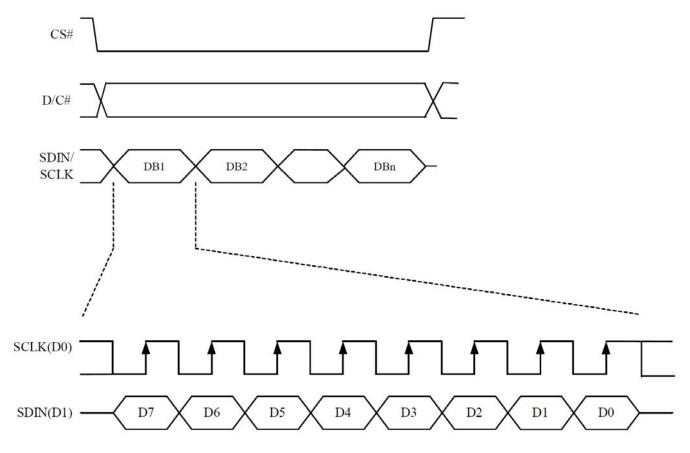


Figure 10-4-2: Write procedure in 4-wire SPI mode

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	42 of 52

10.4.3 MCU Serial Interface (3-wire SPI)

The 3-wire serial interface consists of serial clock SCLK, serial data SDIN and CS#. In 3-wire SPI mode, D0 acts as SCLK, D1 acts as SDIN.

The operation is similar to 4-wire serial interface while D/C# pin is not used. There are altogether 9-bits will be shifted into the shift register on every ninth clock in sequence: D/C# bit, D7 to D0 bit. The D/C# bit (first bit of the sequential data) will determine the following data byte in the shift register is written to the Display Data RAM (D/C# bit = 1) or the command register (D/C# bit = 0).

Under serial mode, only write operations are allowed.

Function	CS#	D/C#	SCLK
Write command	L	Tie	↑
Write data	L	Tie	↑

Note: ↑ stands for rising edge of signal

Table 10-4-3: Control pins of 3-wire Serial interface

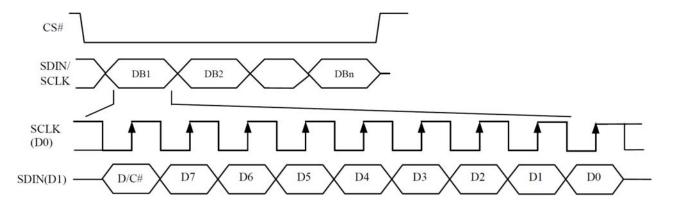


Figure 10-4-3: Write procedure in 3-wire SPI mode

10.4.4 Interface Timing

The following specifications apply for: VSS=0V, VCI=3.0V, T_{OPR} =25°C.

Symbol	Parameter	Test Condition	Applicable pin	Min.	Typ.	Max.	Unit
Fosc	Internal Oscillator frequency	VCI=2.4 to 3.3V	CL	0.95	1	1.05	MHz

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	43 of 52

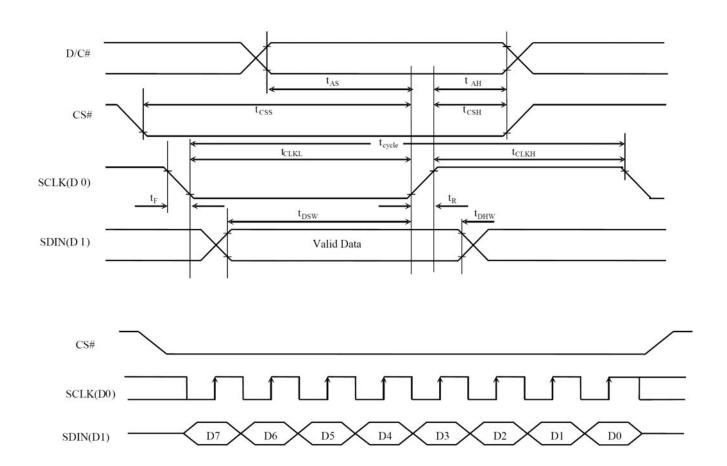


Figure 10-4-4: Serial interface characteristics

 $(V_{CI} - VSS = 2.4V \text{ to } 3.3V, T_{OPR} = 25^{\circ}C, CL=20pF)$

Symbol	Parameter Min.		Typ.	Max.	Unit
t _{cycle}	Clock Cycle Time	250	-	-	ns
t_{AS}	Address Setup Time	150	-	-	ns
t_{AH}	Address Hold Time	150	-	-	ns
t_{CSS}	Chip Select Setup Time	120	-	-	ns
t_{CSH}	Chip Select Hold Time	60	-	-	ns
$t_{ m DSW}$	Write Data Setup Time	50	-	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	-	ns
$t_{ m CLKL}$	Clock Low Time	100	-	-	ns
t_{CLKH}	Clock High Time	100	-	-	ns
t_{R}	Rise Time [20% ~ 80%]	-	-	15	ns
t_{F}	Fall Time [20% ~80%]	-	-	15	ns

Table 10-4-4: Serial Interface Timing Characteristics

Confidential Page 43 of 52 2012-10-22

	File Name	Specification for 2.1" EPD	Module Number	; 89021A1
ĺ	Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	44 of 52

11 Optical Specification

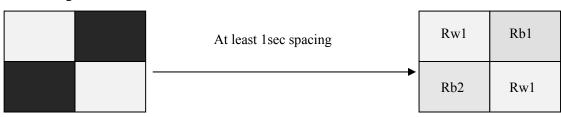
Measurements are made with that the illumination is under an angle of 45 degrees, the detection is perpendicular unless otherwise specified.

Crymh al	Dawamatan	Conditions	Values		Units	Notes	
Symbol	Parameter	Conditions	Min.	Тур.	Max	Units	notes
R	White Reflectivity	White	30	35	-	%	11-1
CR	Contrast Ratio		7:1	8:1	-	-	11-2
T_{update}	Image update time	at 25 °C	-	1800	-	ms	-
Ghosting	Image sticking		-2.0	1.0	2.0	-	11-3

Notes: 11-1. Luminance meter: Eye-One Pro Spectrophotometer.

- 11-2. CR=Surface Reflectance with all white pixel/Surface Reflectance with all black pixels.
- 11-3. Ghosting Testing:

11-3-1. Testing Pattern



White State

- 11-3-2. Refresh process: Init ---- GC White ---- 4 checkerboard Pattern GC ---- GC White.
- 11-3-3. Measuring the reflectance of all 4 checkerboard areas when final white state by Eye-one device.
- 11-3-4. Rw: reflectance of area transited from white state
 Rb: reflectance of area transited from dark(black) state
- 11-3-5. Calculating averages of WS-to-WS and DS-to-WS transitions: Rw(ave)=(Rw1+Rw2)/2, Rb(ave)=(Rb1+Rb2)/2, G=Rw(ave)-Rb(ave).

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	45 of 52

12 Appearance Inspection Standard

12.1 Major Defects

Defect Type	Description
No display	Not able to display any image
Line defect	Complete line(s) missing or unusual appear when display
Abnormal display	Unusual pattern or function when display

12.2 Minor Defects

		Temperature / Humidity	Environmental iliumination	Distance	Time	Angle	
	rivironmental condition 20°C -25°C 40%RH-55%RH 700-1000Lux		200-300mm	20 sec	Up/down 30 degree (Rotation)		
	NO.	Defect type	Check	Acceptable	A Zone	B Zone	
				D≤0.2mm	Ignore		
	1	Spot (B/W spot, dent in glass or protection sheet, foreign mat. Swell. Dot defect) (unwork)	By eye and gauge	0.2mm <d≦0.3mm< td=""><td>≤4 (two spot spacing greater than 20mm)</td><td></td></d≦0.3mm<>	≤4 (two spot spacing greater than 20mm)		
				$0.3\text{mm} < D \le 0.35\text{mm}$	N≦1		
appearance Inspection				D>0.35mm	NG		
standard				$L \le 0.5 \text{mm}$ & $W \le 0.2 \text{mm}$	Ignore	OK	
	Scratch or line defect (scratch or foreign mat. Protection sheet)	By eye and gauge	0.5 mm< L ≤ 3mm & 0.2mm <w≤0.3mm< td=""><td>≤2 (the center of two line spacing greater than 30mm)</td><td></td></w≤0.3mm<>	≤2 (the center of two line spacing greater than 30mm)			
		(unwork)		L>3.0mm or W>0.3mm	NG		
			D 1	D1/D2 ≤ 0.2mm	Ignore		
	3	Air bubble	By eye and gauge	$0.2 \text{mm} < D1/D2 \le 0.5 \text{mm}$	N≦3		
			Suuge	D1/D2>0.5mm	NG		
	4	Stab	By eye	No hurt PET	NG		

Note: 1. Spot size is based on microscope $10x\sim100x$

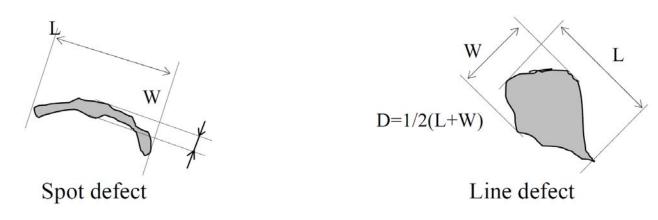
2. Spot define: That only can be seen under WS, BS or GS defects.

3. A Zone: Active area(defined in specification)

B Zone: Border area from A Zone edge

File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	46 of 52

12.3 Spot and Line Defect Test and Calculation



12.4 Spot and Line Test Standard

When $L \le 0.5$ mm, test as point. When L < 4W, test as point.

12.5 Air Bubble Defect Test and Calculation



File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	47 of 52

13 Handling, Safety, and Environment Requirements

Warning

The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.

Caution

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components. Disassembling the display module.

Disassembling the display module can cause permanent damage and invalidates the warranty agreements.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricality and other rough environmental conditions.

Data sheet status		
Product specification	This data sheet contains final product specifications.	
Limiting values		

Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information

Where application information is given, it is advisory and does not form part of the specification.

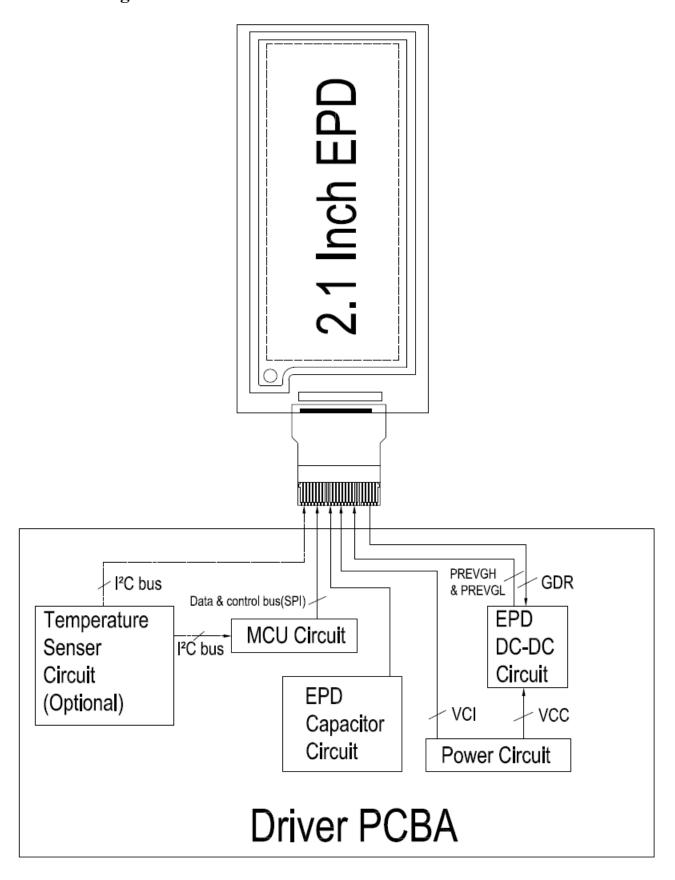
	File Name	Specification for 2.1" EPD	Module Number; 89021A1	
Ī	Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	48 of 52

14 Reliability Test

No.	Test	Condition	Method	Remark
1	High- Temperature Operation	T = +50°C, RH = 30% for 240 hrs	IEC 60 068-2-2Bp	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
2	Low- Temperature Operation	T = 0°C for 240 hrs	IEC 60 068-2-2Ab	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
3	High- Temperature Storage	T = +70°C, RH=23% for 240 hrs	IEC 60 068-2-2Bp	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
4	Low- Temperature Storage	T = -25°C for 240 hrs	IEC 60 068-2-1Ab	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
5	High- Temperature, High- Humidity Operation	T = +40°C, RH = 90% for 168 hrs	IEC 60 068-2-3CA	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
6	High Temperature, High- Humidity Storage	T = +60°C, RH=80% for 240hrs	IEC 60 068-2-3CA	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
7	Thermal Shock	1 cycle:[-25°C 30min]→[+70 °C 30 min] : 30 cycles	IEC 60 068-2-14	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
8	Package Vibration	1.04G, Frequency: 10~500Hz Direction: X,Y,Z Duration: 1 hours in each direction	Full packed for shipment	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
9	Package Drop Impact	Drop from height of 122 cm on concrete surface. Drop sequence: 1 corner, 3edges, 6 faces One drop for each	Full packed for shipment	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
10	Electrostatic Effect (non- operating)	Machine model +/- 250V, 0Ω , 200pF	IEC 62179, IEC 62180	At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
11	Altitude test Operation	700hPa (= 3000m) 48Hr		At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.
12	Altitude test Storage	260hPa (= 10000m) 48Hr		At the end of the test, electrical, mechanical, and optical specifications shall be satisfied.

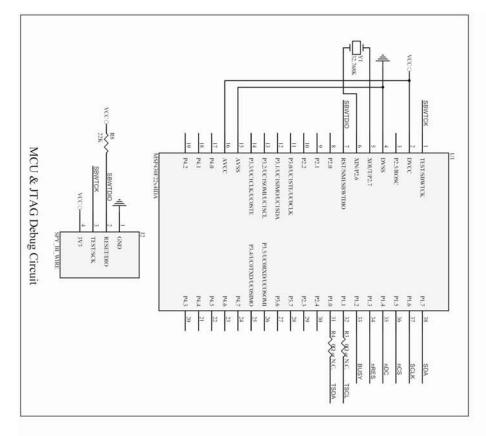
File Name	Specification for 2.1" EPD	Module Number	·····; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	49 of 52

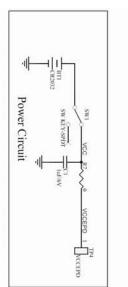
15 Block Diagram

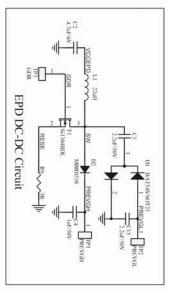


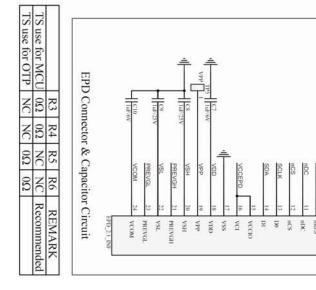
File Name	Specification for 2.1" EPD	Module Number	; 89\$&%5%
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	50 of 52

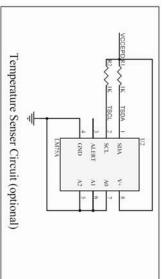
16 Typical Application Circuit with SPI Interface





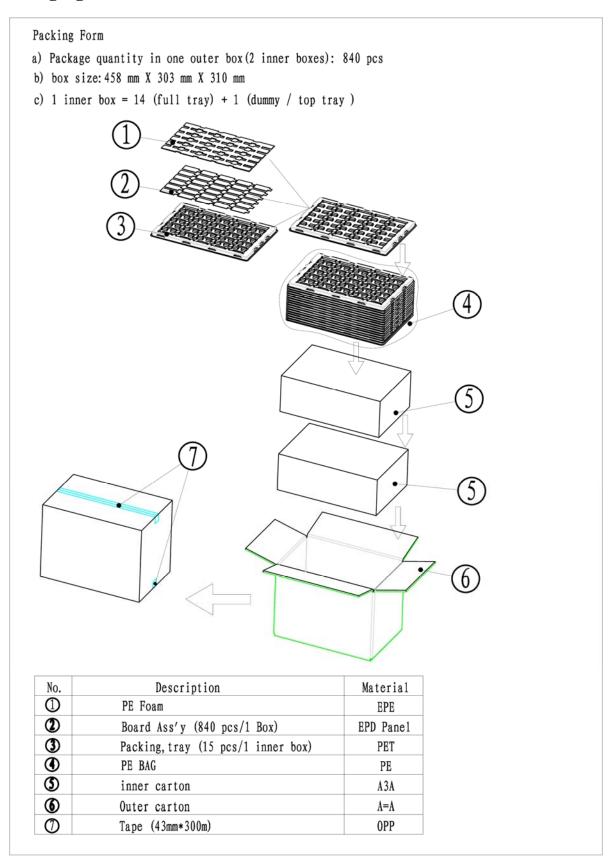






File Name	Specification for 2.1" EPD	Module Number	; 89\$&%5%
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	51 of 52

17 Packaging



File Name	Specification for 2.1" EPD	Module Number	; 89021A1
Version	A/0(For SLC 505a FH E21002-DL Ver02 TFT	Page Number	52 of 52

18 Mark and Bar Code Definition



- (1) YYYYYYYY: Module No.
- (2) MMMMMMM: Product date: year month day.
- (3) Bar Code definition.
 - <u>T 01 B S215AB YYY 00001</u>
 - (1) (2) (3) (4) (5) (6)
 - (1) Module Assemble Vendor.
 - (2) Version.
 - (3) Application.
 - (4) G-Paper Film LOT.
 - (5) Product LOT.
 - (6) Product Serial Number.